



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

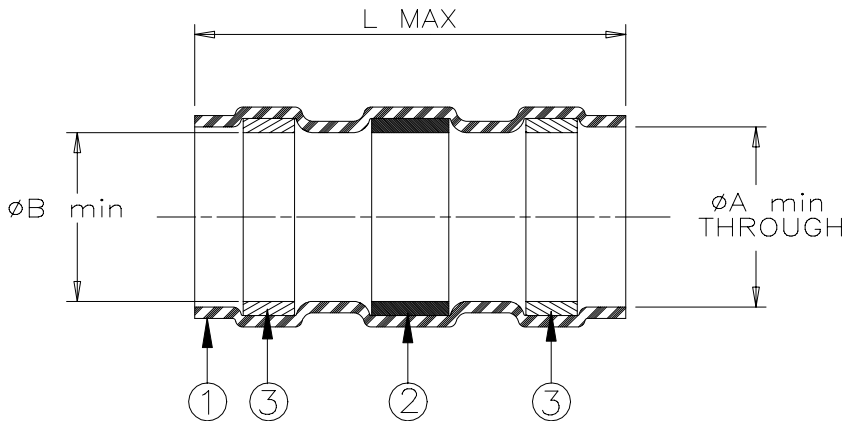
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# CUSTOMER DRAWING




Product Name	Product Dimensions		
	øA min	øB min	L max
B-023-00	4.3	5.6	31
B-023-01	5.5	5.5	41
B-023-02	7.0	8.13	39
B-023-03	10.5	10.5	45
B-023-04	2.4	3	19
B-023-07	3.1	4.5	29

## MATERIALS

- INSULATION SLEEVE: Heat-shrinkable, transparent clear, modified polytetrafluorethylene.
- SOLDER PREFORM WITH FLUX:  
 SOLDER: TYPE Pb93 per ANSI-J-STD-006.  
 FLUX: TYPE ROM1 per ANSI-J-STD-004.
- MELTABLE SEALING RINGS: Modified fluorinated ethylene propylene.

## APPLICATION

- These controlled soldering devices are designed for termination of a nickel plated copper shield of a cable having an insulation rated for at least 200°C continuous.
- Temperature range: -65°C to +260°C. For cable preparation and installation tool, consult RPIP-666-00.

		Tyco Electronics 300 Constitution Dr Menlo Park, CA 94025, U.S.A.		TITLE: SOLDER SLEEVE DEVICE SHIELD TERMINATION HIGH TEMPERATURE	
Unless otherwise specified dimensions are in millimeters. [Inches dimensions are shown in brackets]		Raychem Devices		DOCUMENT NO.: B-023-0X	
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A	ANGLES: N/A ROUGHNESS IN MICRON	Tyco Electronics reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application.		REV: A	DATE: 27-Aug-07
DRAWN BY: P.TALLY	CAGE CODE: 06090	FILE: B-023-0X_CD	ECO: 07-020120	SCALE: NTS	SIZE: A SHEET: 1 of 1

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